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Specification	
Part Number:	
Version:	
Date:	

Revision		
1.0	2015.07.08	FIRST ISSUE

Contents

General Description

*** Description**

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorpho us silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 2.4'TFT-LCD contains 240*320 pixels, and can displ ay up to 65K/262K colors.

*** Features**

-Low Input Voltage: 3.3V (TYP)

-Display Colors of TFT LCD: 65K/262K colors

- TFT Interface: 8/9/16/18BIT 8080 MCU interface
  3/4-wire serial interface;
  16/18BIT RGB.

-CTP Interface: I2C

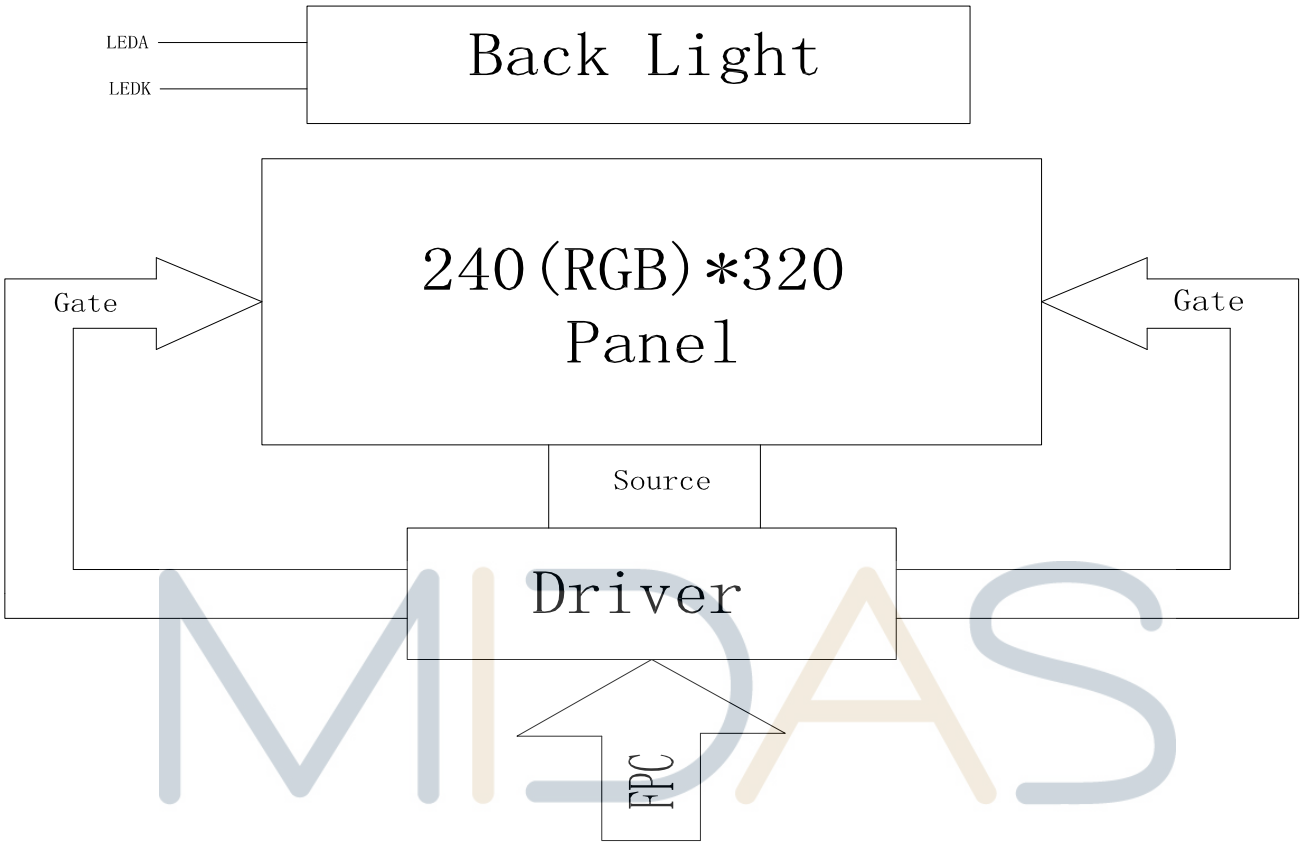
eral Information Items	Specification	Unit	Note
	Main Panel		
TFT Display area(AA)	36.72(H)* 48.96 (V) (2.4inch)	mm	-
CTP View area	37.72(H)* 49.96 (V)	mm	
Driver element	TFT active matrix	-	-
Display colors	65K/262K	colors	-
Number of pixels	240(RGB)*320	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.153(H)*0.153(V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	ST7789V	-	-
CTP Driver IC	FT6236		
Touch mode	Single point and Gestures		
Display mode	Transmissive/Normally Black	-	-
Operating temperature	-20～+70	℃	-
Storage temperature	-30～+80	℃	-

*** Mechanical Information**

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		48.72		mm	-
	Vertical(V)		70.26		mm	-
	Depth(D)		3.88		mm	-

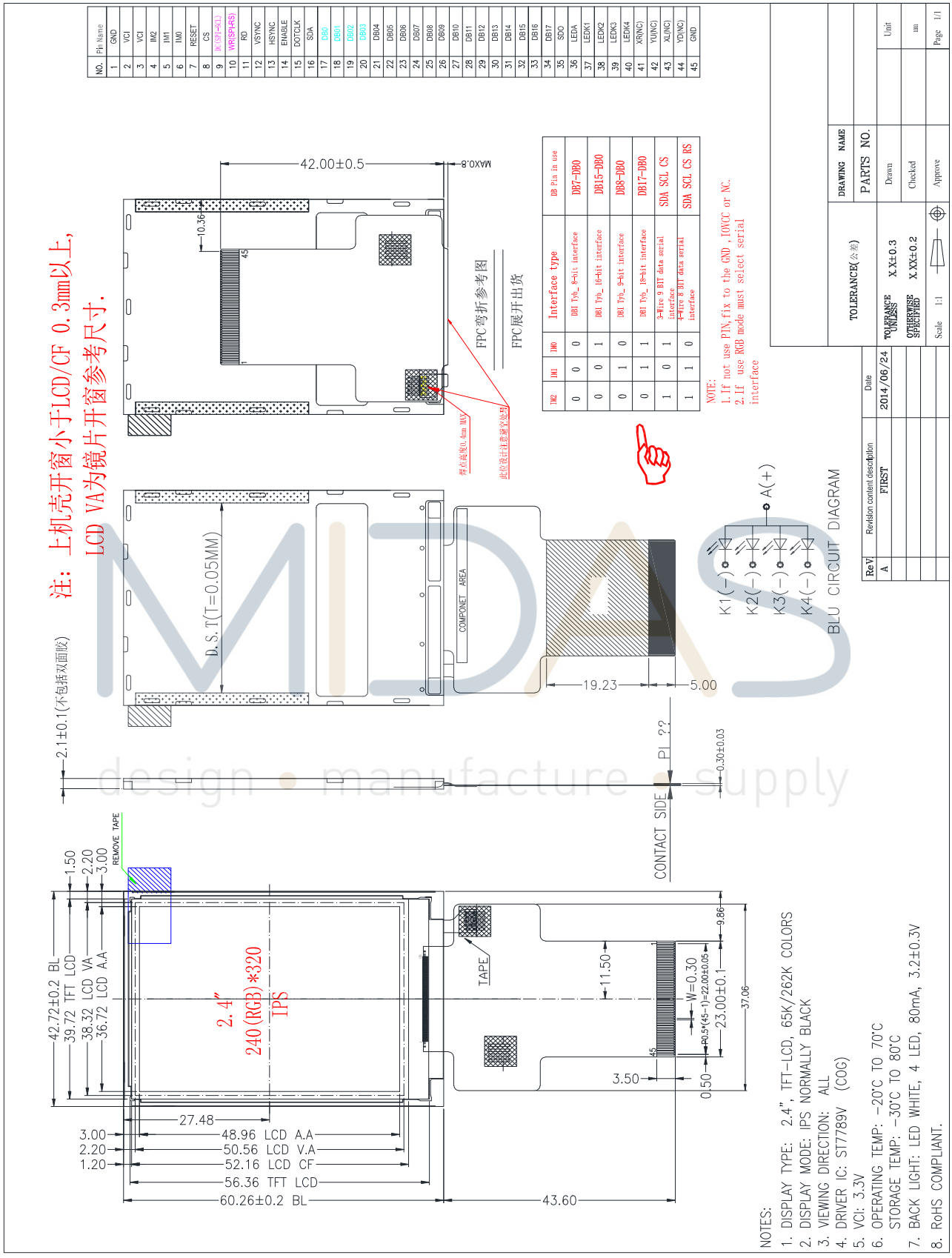
Weight		TBD		g	-

1. Block Diagram



2. Outline dimension

2.1 LCM

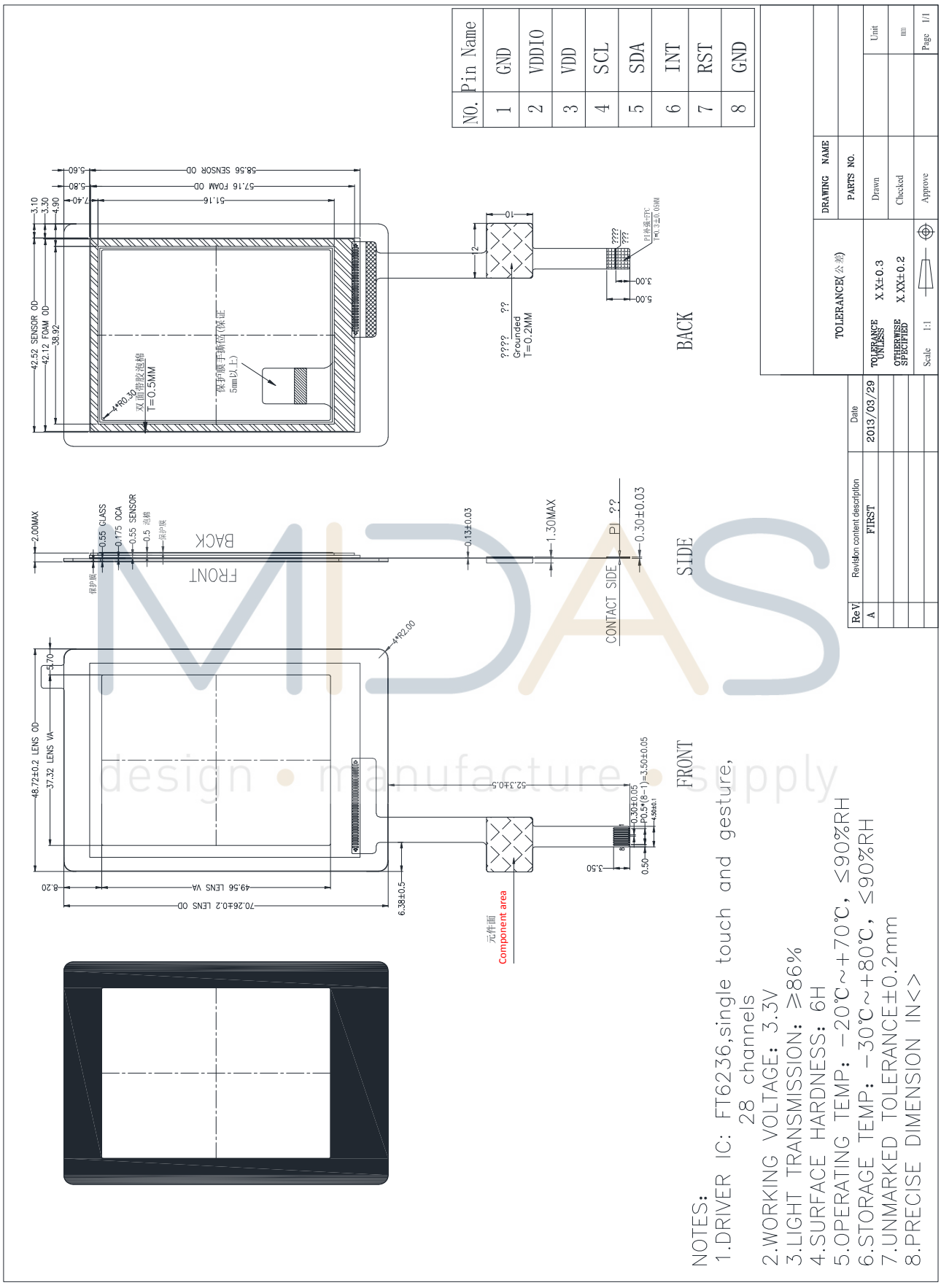


NO.	Pin Name
1	GND
2	VCI
3	VCI
4	IM2
5	IM1
6	IM0
7	RESET
8	CS
9	RS(SPI-SCL)
10	WR(SPI-SI)
11	RD
12	VSYNC
13	HSYNC
14	ENABLE
15	DOTCLK
16	SDA
17	DB0
18	DB01
19	DB02
20	DB03
21	DB04
22	DB05
23	DB06
24	DB07
25	DB08
26	DB09
27	DB10
28	DB11
29	DB12
30	DB13
31	DB14
32	DB15
33	DB16
34	DB17
35	SDO
36	LEDA
37	LEDK1
38	LEDK2
39	LEDK3
40	LEDK4
41	XR(NC)
42	YU(NC)
43	XL(NC)
44	YD(NC)
45	GND

IM2	IM1	IM0	Interface type	DB Pin in use
0	0	0	DBI Typ_ 8-bit interface	DB7-DB0
0	0	1	DBI Typ_ 16-bit interface	DB15-DB0
0	1	0	DBI Typ_ 9-bit interface	DB8-DB0
0	1	1	DBI Typ_ 18-bit interface	DB17-DB0
1	0	1	3-Wire 9 BIT data serial interface	SDA SCL CS
1	1	0	4-Wire 8 BIT data serial interface	SDA SCL CS RS

NOTES:
1. DISPLAY TYPE: 2.4", TFT-LCD, 65K/262K COLORS
2. DISPLAY MODE: IPS NORMALLY BLACK
3. VIEWING DIRECTION: ALL
4. DRIVER IC: ST7789V (COG)
5. VCI: 3.3V
6. OPERATING TEMP: -20°C TO 70°C
   STORAGE TEMP: -30°C TO 80°C
7. BACK LIGHT: LED WHITE, 4 LED, 80mA, 3.2±0.3V
8. RoHS COMPLIANT.

2.2 CTP


NO. Pin Name
1 GND
2 VDDIO
3 VDD
4 SCL
5 SDA
6 INT
7 RST
8 GND
BACK
SIDE
FRONT
NOTES:
1.DRIVER IC: FT6236,single touch and gesture, 28 channels
2.WORKING VOLTAGE: 3.3V
3.LIGHT TRANSMISSION: ≥86%
4.SURFACE HARDNESS: 6H
5.OPERATING TEMP: -20℃~+70℃, ≤90%RH
6.STORAGE TEMP: -30℃~+80℃, ≤90%RH
7.UNMARKED TOLERANCE±0.2mm
8.PRECISE DIMENSION IN<>
TOLERANCE(公差)
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Component area
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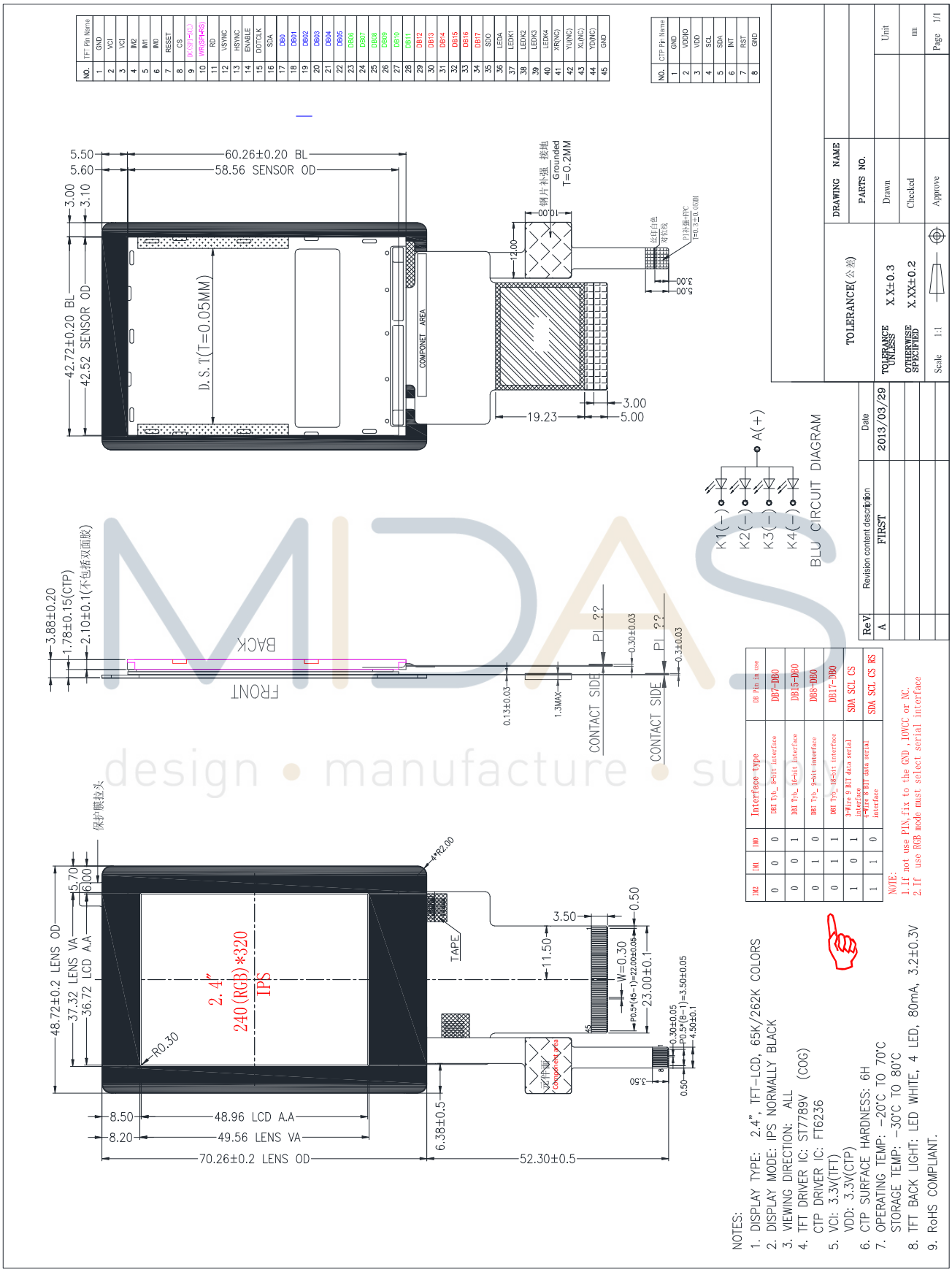
FRONT
BACK

2.3 LCM+CTP


NOTES:
1. DISPLAY TYPE: 2.4", TFT-LCD, 65K/262K COLORS
2. DISPLAY MODE: IPS NORMALLY BLACK
3. VIEWING DIRECTION: ALL
4. TFT DRIVER IC: ST7789V (COG)
CTP DRIVER IC: FT6236
5. VCI: 3.3V(TFT)
VDD: 3.3V(CTP)
6. CTP SURFACE HARDNESS: 6H
7. OPERATING TEMP: -20°C TO 70°C
STORAGE TEMP: -30°C TO 80°C
8. TFT BACK LIGHT: LED WHITE, 4 LED, 80mA, 3.2±0.3V
9. RoHS COMPLIANT.
2.4"
240(RGB)*320
IPS
TAPE
FRONT
BACK
CONTACT SIDE
BLU CIRCUIT DIAGRAM
TOLERANCE(公差)
DRAWING NAME
PARTS NO.
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Rev
Revision content description
Date
FIRST
2013/03/29

3. Input terminal Pin Assignment

3.1 TFT

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	VCI	Supply voltage(3.3V).	P
3	VCI	Supply voltage(3.3V).	P
4	IM2	MPU Parallel interface bus and serial interface select If use RGB Interface must select serial interface. Fix this pin at VCI and GND.	I
5	IM1		I
6	IM0		I
7	RESET	This signal will reset the device and must be applied to properly initialize the chip.	I
8	CS	Chip select input pin (“Low” enable). fix this pin at VCI or GND when not in use.	I
9	DC(SCL)	This pin is used to select “Data or Command” in the parallel interface. When D/CX = ’1’, data is selected. When D/CX = ’0’, command is selected. This pin is used serial interface clock in 3-wire 9-bit / 4-wire 8-bit serial data interface. fix this pin at VCI or GND when not in use.	I
10	WR(SPI-RS)	The data is applied on the rising edge of the SCL signal. If not used, fix this pin at VCI or GND when not in use.	I
11	RD	Serves as a read signal and MCU read data at the rising edge. fix this pin at VCI or GND when not in use.	I
12	VSYNC	Frame synchronizing signal for RGB interface operation. fix this pin at VCI or GND when not in use.	I
13	HSYNC	Line synchronizing signal for RGB interface operation. fix this pin at VCI or GND when not in use.	I
14	ENABLE	Data enable signal for RGB interface operation.	I

		fix this pin at VCI or GND when not in use.	
15	DOTCLK	Dot clock signal for RGB interface operation. Fix this pin at VCI or GND when not in use.	I
16	SDA	Serial input signal. The data is latched on the rising edge of th e SCL signal. fix this pin at VCI or GND when not in use.	I
17-34	DB0-DB17	18-bit parallel bi-directional data bus for MCU system and RGB interface mode . Fix to GND level when not in use	I/0
35	SDO	SPI interface output pin. -The data is output on the falling edge of the SCL signal. -If not used, let this pin open.	O
36	LEDA	Anode pin of backlight	P
37	LEDK1	Cathode pin OF backlight	P
38	LEDK2	Cathode pin OF backlight	P
39	LEDK3	Cathode pin OF backlight	P
40	LEDK4	Cathode pin OF backlight	P
41	XR	Touch panel Right Glass Terminal	A/D
42	YD	Touch panel Bottom Film Terminal	A/D
43	XL	Touch panel LIFT Glass Terminal	A/D
44	YU	Touch panel Top Film Terminal	A/D
45	GND	Ground.	P

3.2 CTP

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	VDDIO	I/O power supply voltage.	P
3	VDD	Supply voltage.	P
4	SCL	I2C clock input.	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt to the host.	I
7	RST	External Reset, Low is active.	I
8	GND	Ground.	P

4. LCD Optical Characteristics

4.1 Optical specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Transmittance (with Polarizer)		T (%)	Θ=0 Normal viewing angle	—	4.65	—	%	Measuring with Polarizer, Reference Only
Transmittance (without Polarizer)		T (%)		—	14.6	—	%	
Contrast		CR		640	800	—	—	(1)(2)
Response time	Rising	T_R		—	16	21	msec	(1)(3)
	Falling	T_F		—	19	24		
Color gamut	(%)			—	70	—	%	C-light
Color chromaticity (CIE1931)	White	W_x		0.290	0.310	0.330	—	(1)(4) CF glass
		W_y		0.316	0.336	0.356		
	Red	R_x		0.627	0.647	0.667	—	
		R_Y		0.297	0.317	0.337		
	Green	G_x		0.255	0.275	0.295	—	
		G_Y		0.562	0.582	0.602		
	Blue	B_x		0.120	0.140	0.160	—	
		B_Y		0.068	0.088	0.108		
Viewing angle	Hor.	Θ_L	CR>10	—	80	—	—	(1)(4) Measuring with Polarizer, Reference Only
		Θ_R		—	80	—		
	Ver.	Θ_U		—	80	—		
		Θ_D		—	80	—		
Optima View Direction		Free						(5)

4.2 Measuring Condition

■ Measuring surrounding：dark room

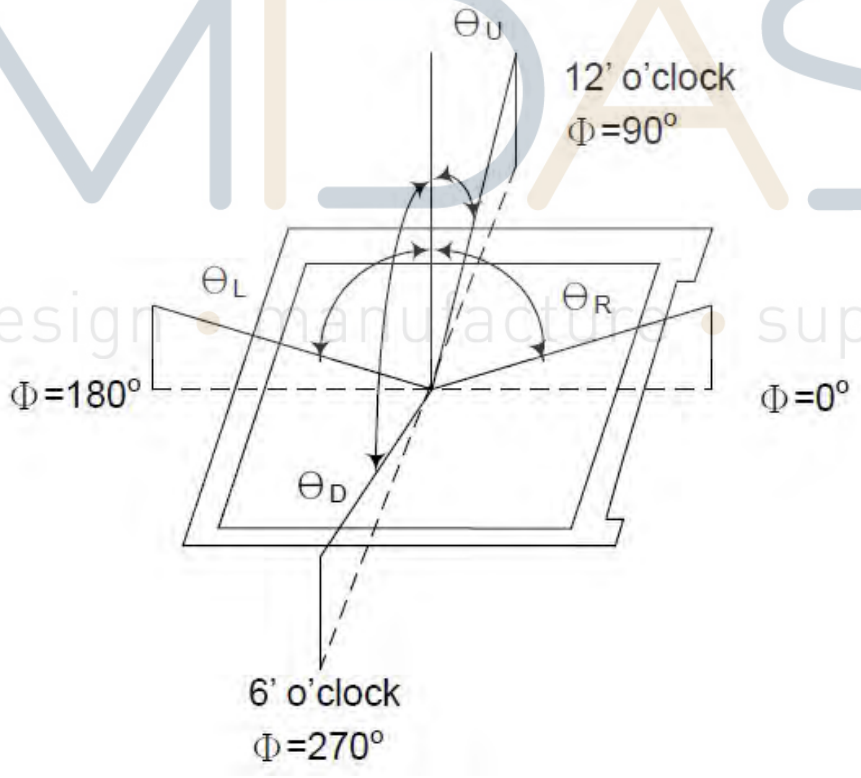
■ Ambient temperature：25±2℃

■ 15min. warm-up time.

4.3 Measuring Equipment

Chromaticity and BM-5A for other optical characteristics.

Note (1) Definition of Viewing Angle:



Note (2) Definition of Contrast Ratio (CR) :
measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

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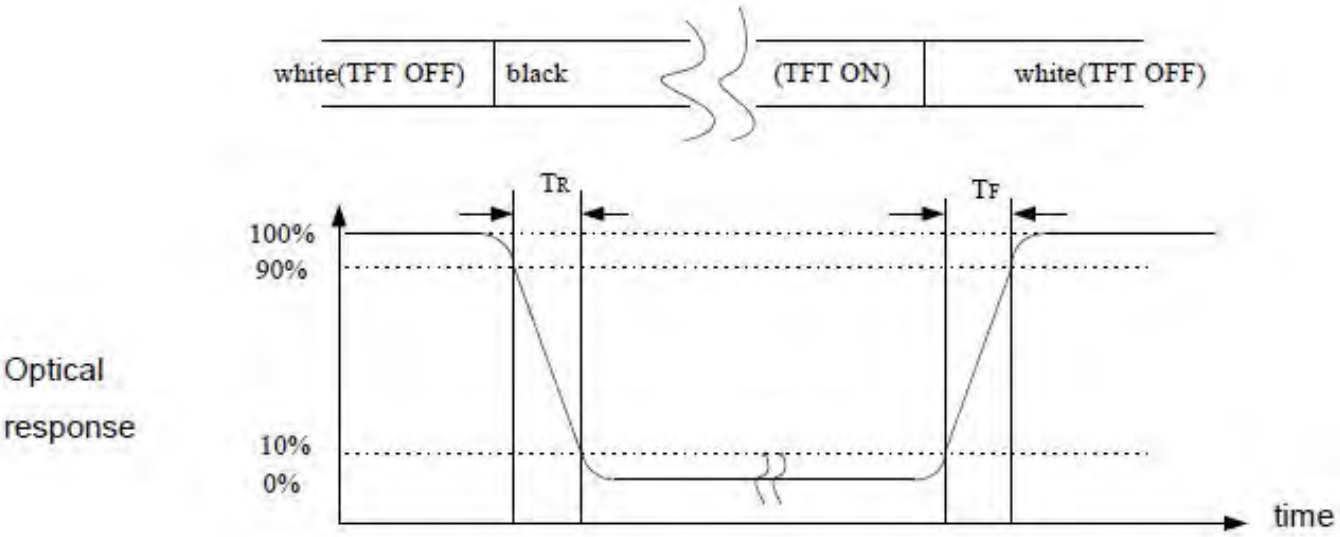
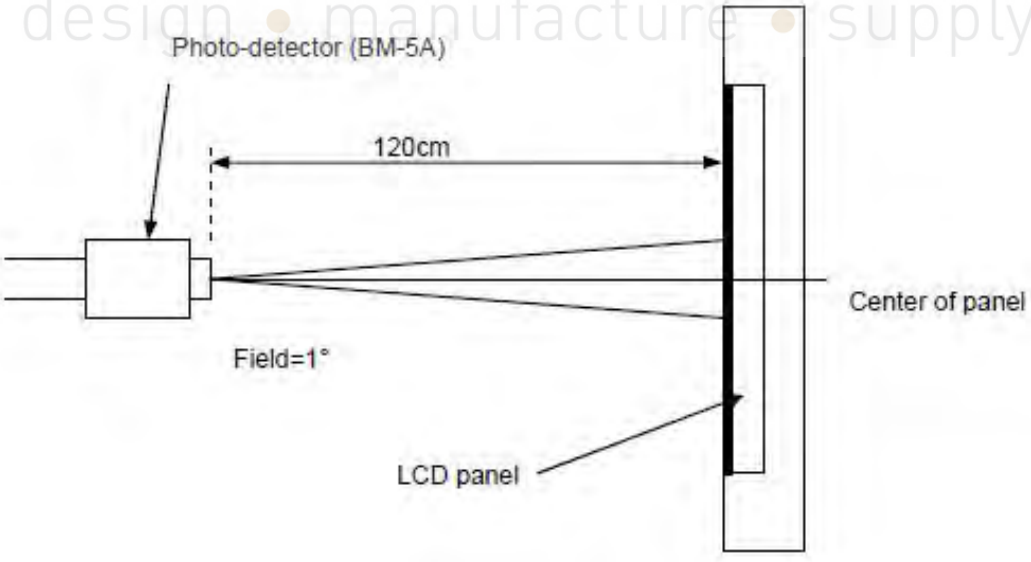
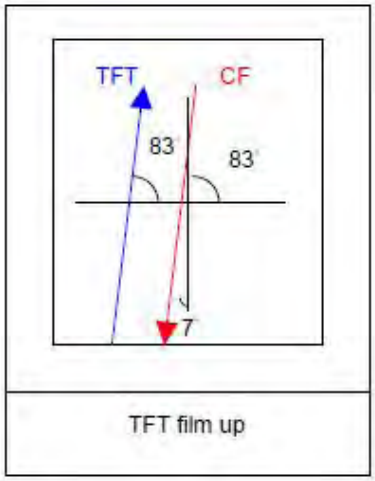
Note (3) Definition of Response Time : Sum of T_R and T_F



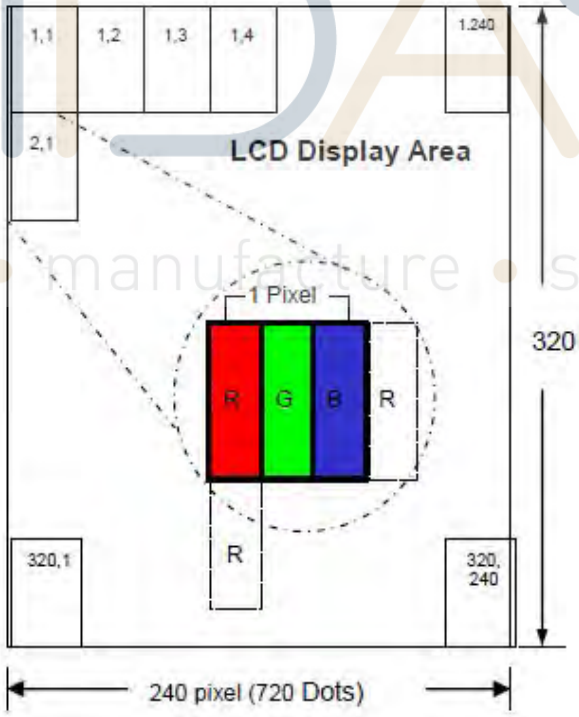
Note (4) Definition of optical measurement setup



Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.



5.0 Pixel Format



5. TFT Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VDD	-0.3	4.6	**V**
Digital interface supple Voltage	VDDIO	-0.3	4.6	**V**
Operating temperature	T_{OP}	-20	+70	℃
Storage temperature	T_{ST}	-30	+80	℃

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VDD	2.4	3.3	4.2	V	
Digital interface supple Voltage	VDDIO	1.65	3.3	4.2	V	
Normal mode Current consumption	IDD	--	8	--	mA	
Level input voltage	V_{IH}	0.7V_{DDIO}		VDDIO	V	
	V_{IL}	GND		0.3V_{DDIO}	V	
Level output voltage	V_{OH}	0.8VDDIO		VDDIO	V	
	V_{OL}	GND		0.2VDDIO	V	

5.3 LED Backlight Characteristics

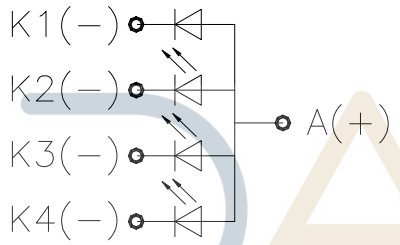
The back-light system is edge-lighting type with 4 chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	60	80	--	mA	
Forward Voltage	V_F	--	3.2	--	V	
LCM Luminance	L_V	450		--	cd/m2	I_F =80mA

LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	AVg	80	--	--	%	

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 ℃, typical IL value indicated in the above table until the brightness becomes less than 50%.

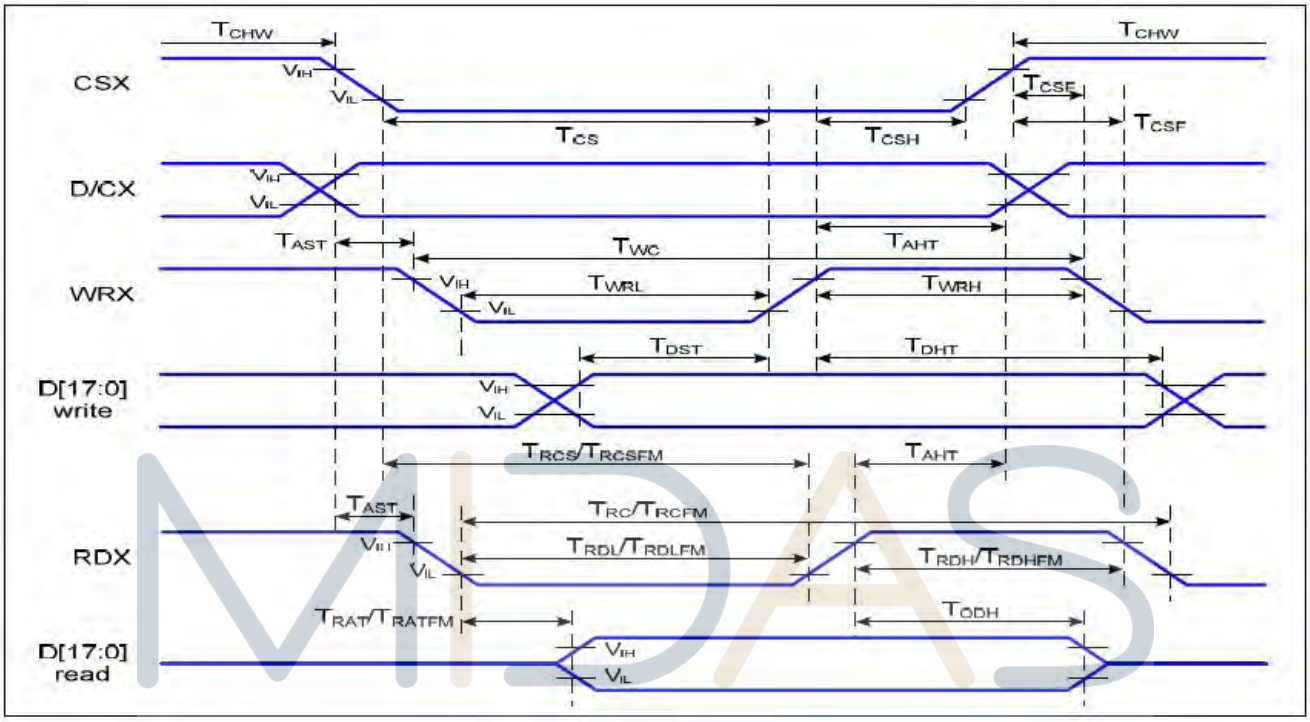
Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 ℃ and IL=80mA. The LED lifetime could be decreased if operating IL is larger than 80mA. The constant current driving method is suggested.



BLU CIRCUIT DIAGRAM

6. TFT AC Characteristic

6.1 8080 Series MCU Parallel Interface Timing Characteristics: 18/16/9/8-bit Bus



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 ℃

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	-
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	-
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	
	T_{WRH}	Control pulse "H" duration	15		ns	
	T_{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF
	T_{DHT}	Data hold time	10		ns	
	T_{RAT}	Read access time (ID)		40	ns	
	T_{RATFM}	Read access time (FM)		340	ns	
	T_{ODH}	Output disable time	20	80	ns	

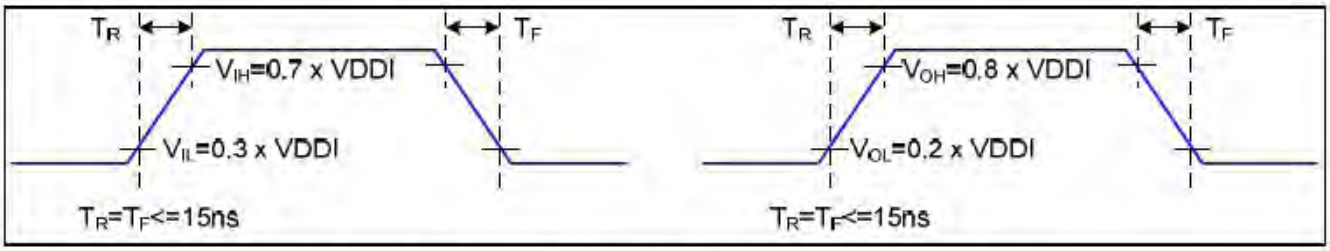


Figure 2 Rising and Falling Timing for I/O Signal

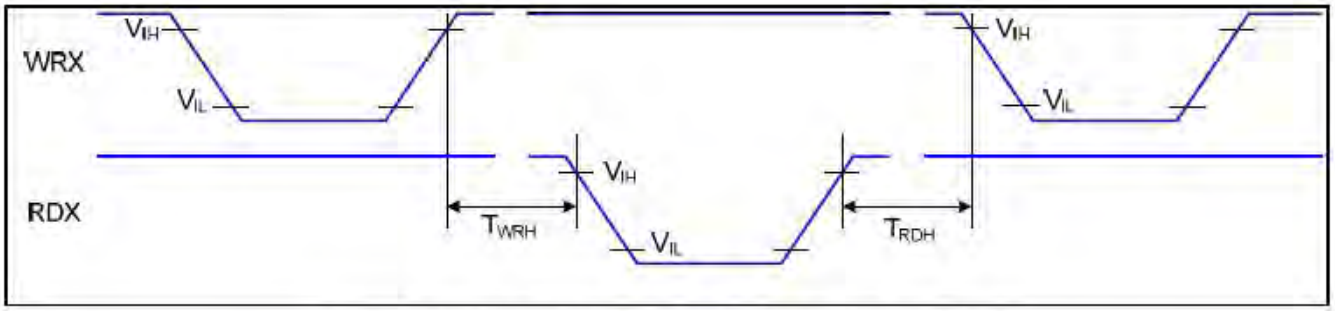
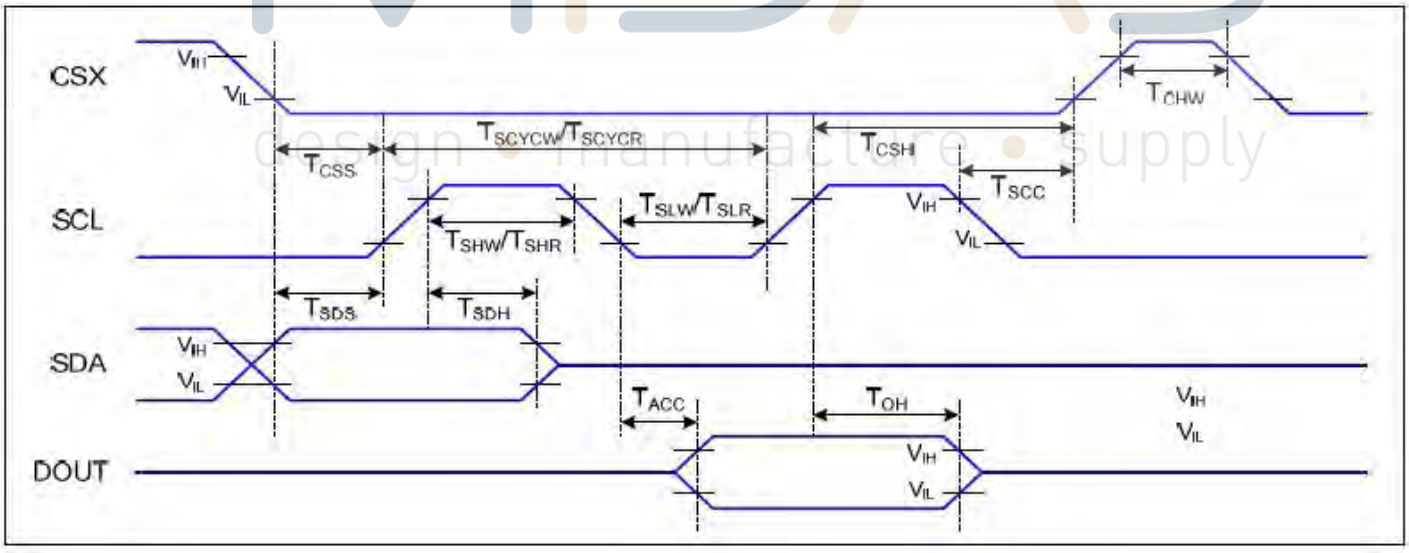


Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (Tr, Tf) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

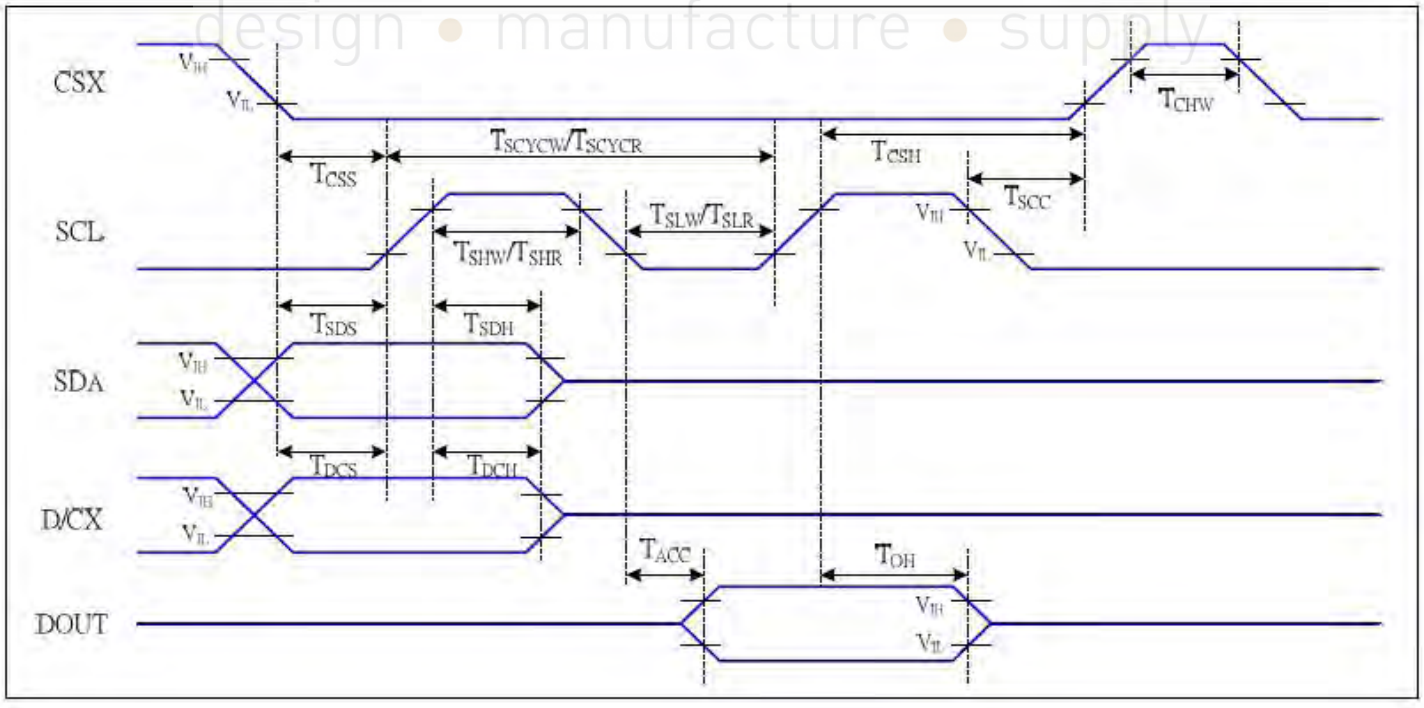
6.2 Display Serial Interface Timing Characteristics (3-line SPI system)



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 C

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

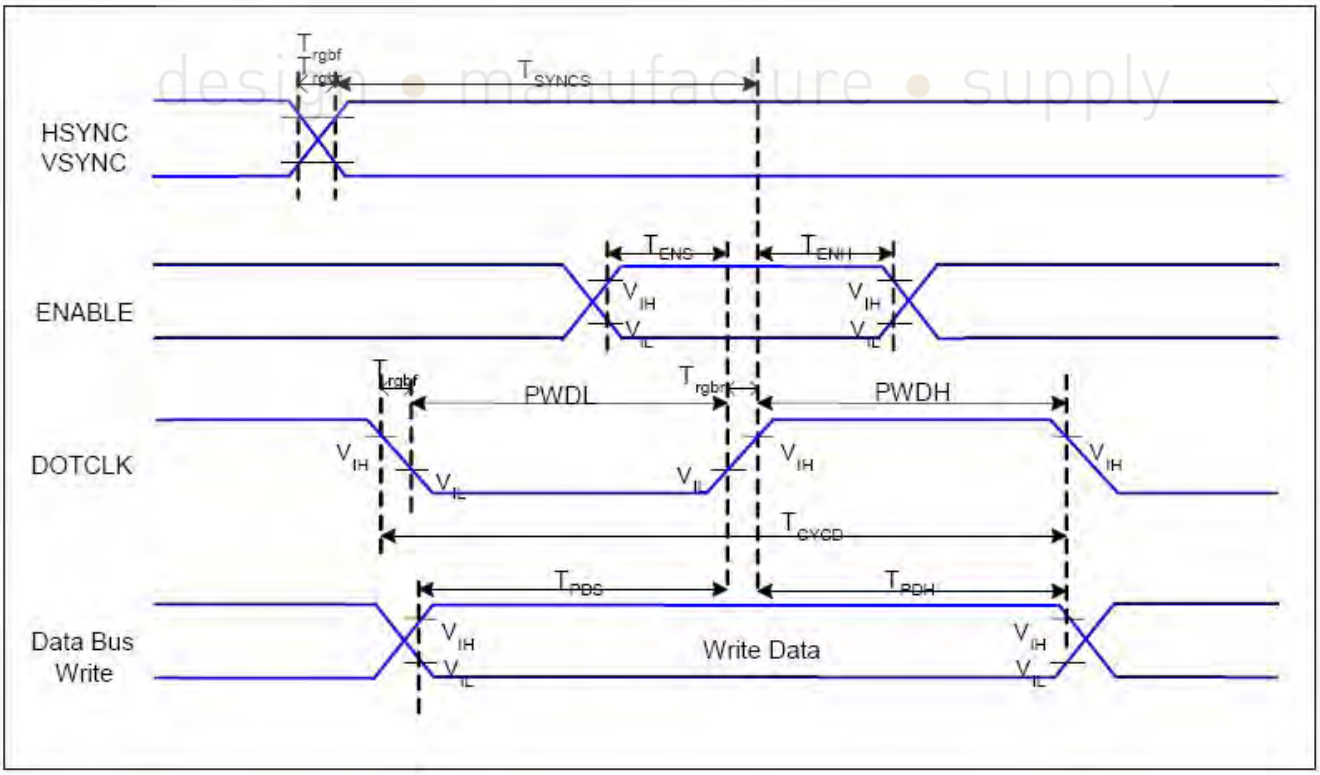
3 Display Serial Interface Timing Characteristics (4-line SPI system)



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data ram
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T_{DCS}	D/CX setup time	10		ns	
	T_{DCH}	D/CX hold time	10		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

6.4 Parallel RGB Interface Timing Characteristics



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYNC, HSYNC Setup Time	30	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	25	-	ns	
	T_{ENH}	Enable Hold Time	25	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
	T_{CYCD}	DOTCLK Cycle Time	120	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	20	ns	
DB	T_{PDS}	PD Data Setup Time	50	-	ns	
	T_{PDH}	PD Data Hold Time	50	-	ns	

Parameters	Symbols	Condition	Min.	Typ.	Max.	Units
Horizontal Synchronization	Hsync		2	10	16	DOTCLK
Horizontal Back Porch	HBP		2	20	24	DOTCLK
Horizontal Address	HAdr		-	240	-	DOTCLK
Horizontal Front Porch	HFP		2	10	16	DOTCLK
Vertical Synchronization	Vsync		1	2	4	Line
Vertical Back Porch	VBP		1	2	-	Line
Vertical Address	VAdr		-	320	-	Line
Vertical Front Porch	VFP		3	4	-	Line

Setting Example: To set frame frequency to 70Hz:

Internal Clock

Internal Oscillation Clock: 615KHz

DIV[1:0] = 2'b0 (x 1/1)

RTN[4:0] = 5'h1b (27 clocks)

FP = 7'h2 (2 lines), BP = 7'h2 (2 lines), NL = 6'h27 (320 lines)

Frame Rate → 70.30Hz

DOTCLK

HSYNC = 10 CLK

HBP = 20 CLK

HFP=10 CLK

70Hz x (2 + 320 + 2) lines x (10 + 20 + 240 + 10) clocks = 6.35MHz

DOTCLK frequency = 6.35MHz

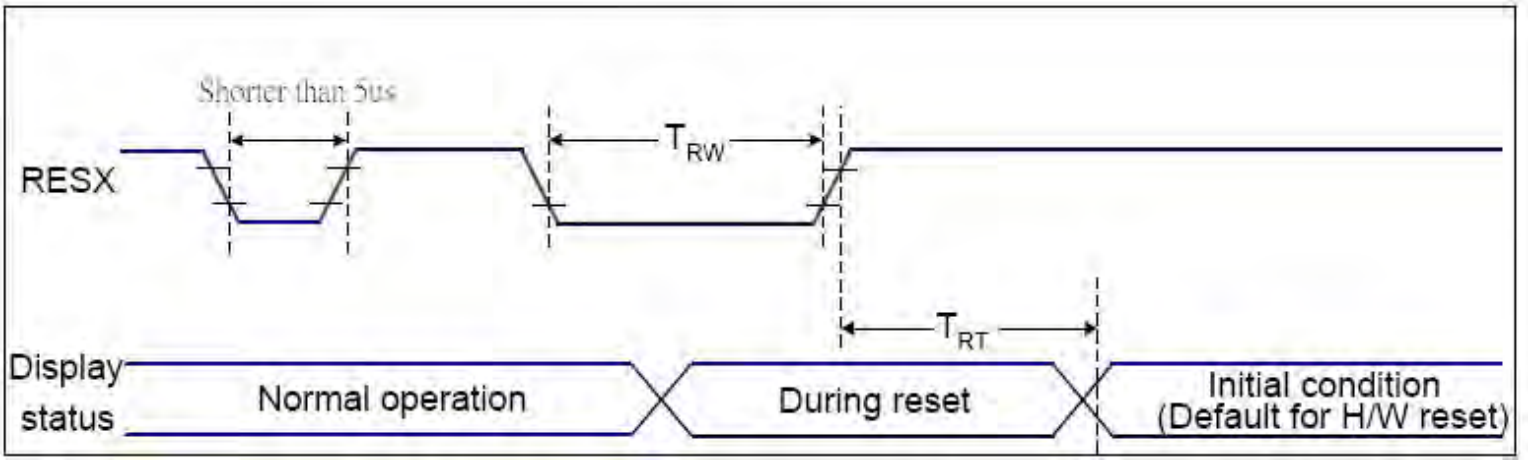
6.35 MHz / 615KHz = 10.32 □ Set PCDIV so that PCLK is divided by 10.

external fosc = 6.35 MHz / 10 = 635KHz

PCDIV = [6.35MHz / 635KHz) / 2] - 1 = 4

PCDIV[5:0] = 6'h04 (10 DOTCLK)

6.5 Reset Timing Characteristics



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 ;

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Notes:

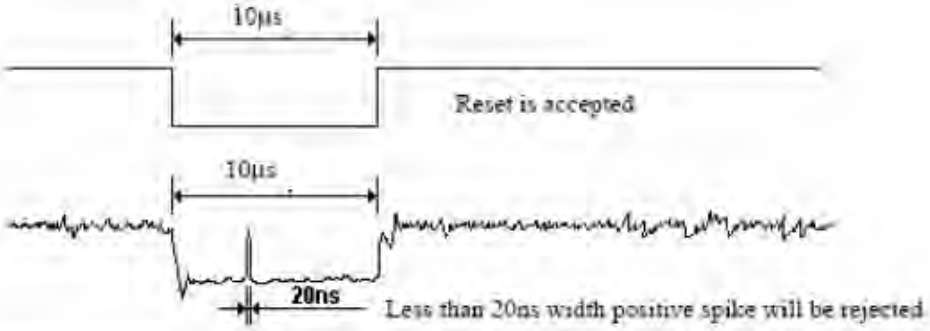
1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.

6. When Reset applied during Sleep Out Mode.

7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

7. CTP Specification

7.1 Electrical Characteristics

7.1.1 Absolute Maximum Rating

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VDD	-0.3	3.6	V	1
I/O Digital Voltage	VDDIO	1.8	3.6	V	1
Operating temperature	T_{OP}	-20	+70	℃	-
Storage temperature	T_{ST}	-30	+80	℃	-

NOTES:

1. *If used beyond the absolute maximum ratings, FT6236 may be permanently damaged. It is strongly recommanded that the device be used within the electrical characteristics in normal operations. If exposed to the condition not within the electrical characteristics, it may affect the reliability of the device.*

7.1.2 DC Electrical Characteristics (Ta=25℃)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Digital supply voltage	VDD		2.8	3.3	3.6	V	
I/O Digital supply voltage	VDDIO		1.8	3.3	3.6	V	
Normal operation mode Current consumption	I_{opr}	VDD=2.8V Ta=25℃ MCLK= 17.5Mhz	-	4	-	mA	
Monitor mode Current consumption	I_{mon}		-	1.5	-	mA	
Sleep mode Current consumption	I_{slp}			50		uA	
Level input voltage	V_{IH}		$0.7V_{DDIO}$	-	V_{DDIO}	V	
	V_{IL}		-0.3	-	$0.3V_{DDIO}$	V	
Level output voltage	V_{OH}	I_{OH}=-0.1mA	$0.7V_{DDIO}$	-	-	V	
	V_{OL}	I_{OH}=0.1mA	-	-	$0.3V_{DDIO}$	V	

7.2 AC Characteristics

Table 4-1 AC Characteristics of Oscillators

Item	Symbol	Test Condition	Min	Typ.	Max	Unit	Note
OSC clock 1	fosc1	VDDA= 2.8V；Ta=25℃	34.65	35	35.35	MHz	

Table 4-2 AC Characteristics of sensor

Item	Symbol	Test Condition	Min	Typ.	Max	Unit	Note
Sensor acceptable clock	ftx	VDDA= 2.8V；Ta=25℃	0	100	300	KHz	
Sensor output rise time	Ttxr	VDDA= 2.8V；Ta=25℃	-	100	-	nS	
Sensor output fall time	Ttxf	VDDA= 2.8V；Ta=25℃	-	80	-	nS	
Sensor input voltage	Trxi	VDDA= 2.8V；Ta=25℃	-	5	-	V	

7.2.1 I2C Interface

The I2C is always configured in the Slave mode. The data transfer format is shown in Figure4-1:

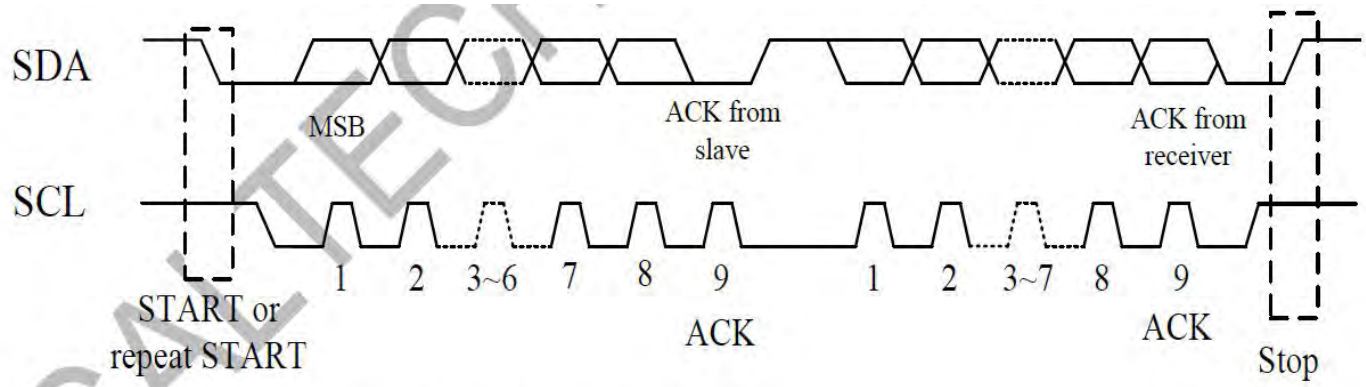


Figure 4-1 I2C Serial Data Transfer Format

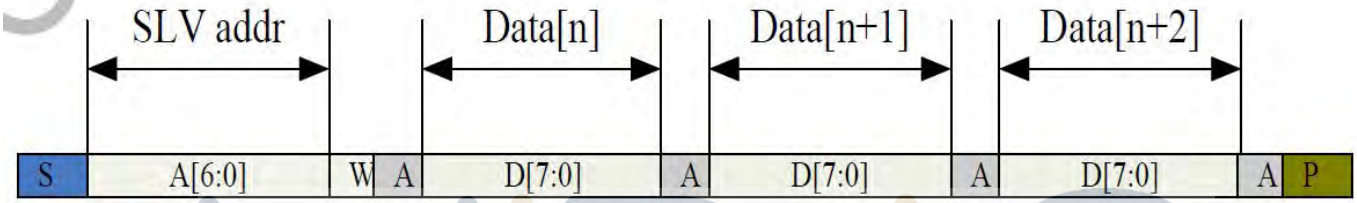


Figure 4-2 I2C master write, slave read

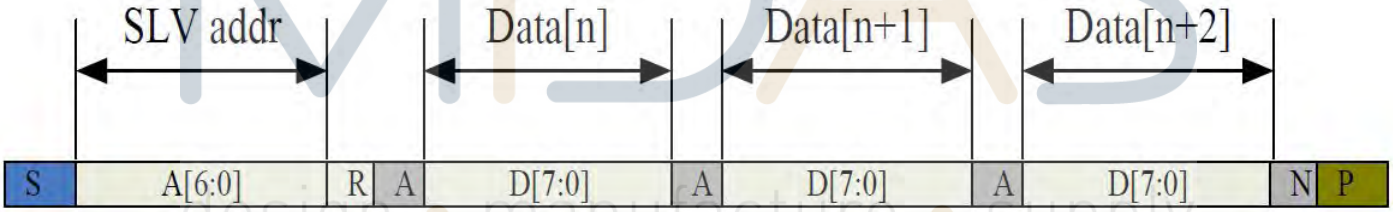


Figure 4-3 I2C master read, slave write

Table4-3 lists the meanings of the mnemonics used in the above figures.

Table 4-3 Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
R/W	READ/WRITE bit, '1' for read, '0'for write
A(N)	ACK(NACK)
P	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

I2C Interface Timing Characteristcs is shown in Table4-4.

Table 4-4 I2C Timing Characteristics

Parameter	Min	Max	Unit
SCL frequency	10	400	KHz
Bus free time between a STOP and START condition	4.7	\	us
Hold time (repeated) START condition	4.0	\	us
Data setup time	250	\	ns
Setup time for a repeated START condition	4.7	\	us
Setup Time for STOP condition	4.0	\	us

8. LCD Module Out-Going Quality Level

8.1 VISUAL & FUNCTION INSPECTION STANDARD

8.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

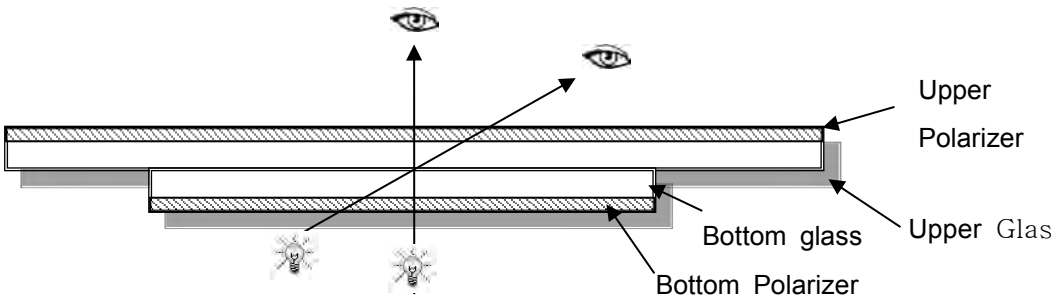
Temperature : 25±5℃

Humidity : 65%±10%RH

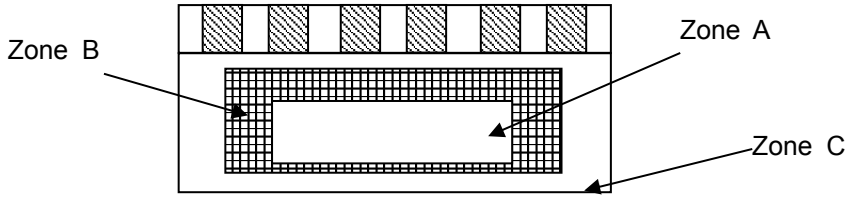
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



8.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer.

8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

AQL:

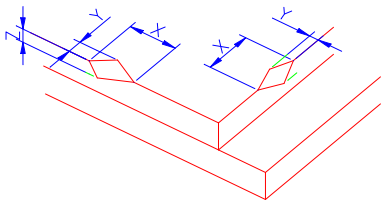
Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

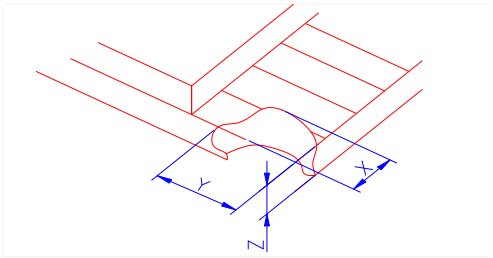
No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

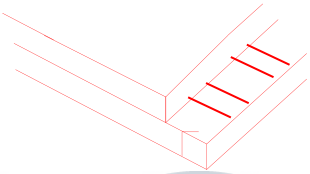
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Soldering appearance	Good soldering , Peeling off is not allowed.	
6	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

8.1.4 Criteria (Visual)

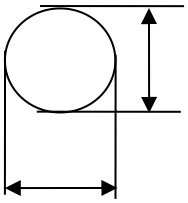
Number	Items	Criteria(mm)
1.0 LCD Crack/Broken NOTE: X: Length Y: Width	(1) The edge of LCD broken	

X	Y	Z
≤3.0mm	<Inner border line of the seal	≤T

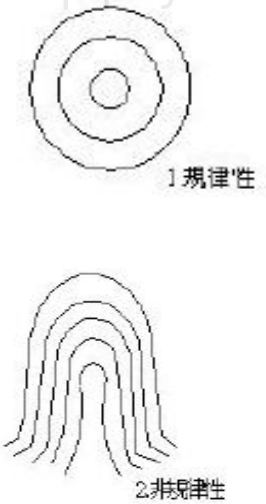
<table>
<tr><td rowspan="2">Z: Height
L: Length of I TO,
T: Height of L CD</td><td>(2)LCD corner broken</td><td> 

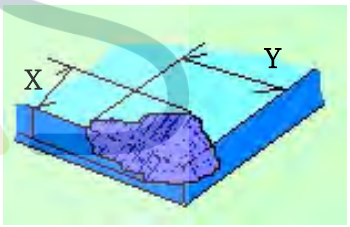
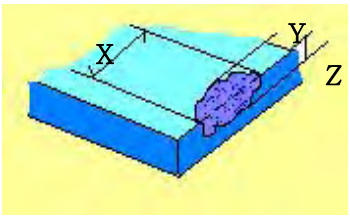
<table>
<tr><td>X</td><td>Y</td><td>Z</td></tr>
<tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr>
</table></td></tr>
<tr><td>(3) LCD crack</td><td> 
Crack
Not allowed</td></tr>
</table>

Number	Items	Criteria (mm)

<table>
<tr>
<td>2.0</td>
<td>Spot defect
 
Y
X
Φ=(X+Y)/2</td>
<td>① light dot（LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain）
<table>
<tr><td rowspan="2">Zone
Size (mm)</td><td colspan="3">Accep</td></tr>
<tr><td>A</td><td>B</td><td>C</td></tr>
<tr><td>Φ≤0.10</td><td colspan="2">Ignore</td><td rowspan="4">Ignor</td></tr>
<tr><td>0.10<Φ≤0.20</td><td colspan="2">3(distance≧10mm)</td></tr>
<tr><td>0.20<Φ≤0.25</td><td colspan="2">2</td></tr>
<tr><td>Φ＞0.25</td><td colspan="2">0</td></tr>
</table>
②Dim spot（LCD/TP/Polarizer dim dot, light leakage、dark spot）
<table>
<tr><td rowspan="2">Zone
Size (mm)</td><td colspan="3">Acceptable Qty</td></tr>
<tr><td>A</td><td>B</td><td>C</td></tr>
<tr><td>Φ≤0.1</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>0.10<Φ≤0.20</td><td colspan="2">3(distance≧10mm)</td></tr>
<tr><td>0.20<Φ≤0.30</td><td colspan="2">2</td></tr>
<tr><td>Φ＞0.30</td><td colspan="2">0</td></tr>
</table>
③ Polarizer accidented spot
<table>
<tr><td rowspan="2">Zone
Size (mm)</td><td colspan="3">Acceptable Qty</td></tr>
<tr><td>A</td><td>B</td><td>C</td></tr>
<tr><td>Φ≤0.2</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr>
<tr><td>0.3<Φ≤0.5</td><td colspan="2">2(distance≧10mm)</td></tr>
<tr><td>Φ>0.5</td><td colspan="2">0</td></tr>
</table>
</td>
</tr>
<tr>
<td></td>
<td>Line defect (LCD/TP /Polarizer black/white line, scratch, stain)</td>
<td>
<table>
<tr><td rowspan="2">Width(mm)</td><td rowspan="2">Length(mm</td><td colspan="3">Acceptable Qty</td></tr>
<tr><td>A</td><td>B</td><td>C</td></tr>
<tr><td>Φ≤0.03</td><td>Igno</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr>
<tr><td>0.03<W≤0.05</td><td>L≤3.0</td><td colspan="2">N≤2</td></tr>
<tr><td>0.05<W≤0.08</td><td>L≤2.0</td><td colspan="2">N≤2</td></tr>
<tr><td>0.08<W</td><td colspan="4">Define as spot defect</td></tr>
</table>
</td>
</tr>
</table>

<table>
<tr><td>3.0</td><td>Polarizer Bubble</td><td>
<table>
<tr><th rowspan="2">Zone
Size (mm)</th><th colspan="3">Acceptable Qty</th></tr>
<tr><th>A</th><th>B</th><th>C</th></tr>
<tr><td>Φ≤0.2</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>0.2<Φ≤0.4</td><td colspan="2">3(distance≧10</td></tr>
<tr><td>0.4<Φ≤0.6</td><td colspan="2">2</td></tr>
<tr><td>0.6<Φ</td><td colspan="2">0</td></tr>
</table>
</td></tr>
<tr><td>4.0</td><td>SMT</td><td>According to IPC-A-610C class Ⅱ standard . Function defect and missing part are major defect ,the others are minor defect.</td></tr>
</table>

<table>
<tr><td rowspan="3">5.0</td><td rowspan="3">TP Related</td><td>TP bubble/ accidented spot</td><td>
<table>
<tr><th rowspan="2">Size Φ(mm)</th><th colspan="3">Acceptable Qty</th></tr>
<tr><th>A</th><th>B</th><th>C</th></tr>
<tr><td>Φ≤0.1</td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>0.1<Φ≤0.25</td><td colspan="2">3 (distance≧10m</td></tr>
<tr><td>0.25<Φ≤0.3</td><td colspan="2">2</td></tr>
<tr><td>0.3<Φ</td><td colspan="2">0</td></tr>
</table>
</td></tr>
<tr><td>Assembly deflection</td><td colspan="2">beyond the edge of backlight ≤0.15mm</td></tr>
<tr><td>Newton Ring</td><td>Newton Ring area>1/3 TP area NG
Newton Ring area≤1/3 TP area OK</td><td> 
</td></tr>
</table>

<table>
<tr><td></td><td></td><td></td><td></td><td> 
</td></tr>
<tr><td></td><td></td><td>TP corner broken
X：length
Y：width
Z：height</td><td><table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>X≤3.0mm</td><td>Y≤3.0mm</td><td>Z<LCD thickness</td></tr></table>*
Circuitry broken is not allowed.</td><td> 
</td></tr>
<tr><td></td><td></td><td>TP edge broken
X：length
Y：width
Z：height</td><td><table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>X≤6.0mm</td><td>Y≤2.0mm</td><td>Z<LCD thicknes</td></tr></table>* Circuitry broken is not allowed.</td><td> 
</td></tr>
</table>

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed

5	TP no function	Not allowed

9. Reliability Test Result

9.1 Condition

Item	Condition	Sample Size	Test Result	Note
Low Temperature Operating Life test	-20℃, 96HR	3ea	pass	-
Thermal Humidity Operating Life test	70℃90%RH, 96HR	3ea	pass	-
Temperature Cycle ON/OFF test	-20℃ ↔ 70℃, ON/OFF, 20CYC	3ea	pass	(1)
High Temperature Storage test	80℃, 96HR	3ea	pass	-
Low Temperature Storage test	−30℃, 96HR	3ea	pass	-
Thermal Shock Resistance	The sample should be allowed to stand the following 5 cycles of operation: TSTL for 30 minutes -> normal temperature for 5 minutes -> TSTH for 30 minutes -> normal temperature for 5 minutes, as one cycle, then taking it out and drying it at normal temperature, and allowing it stand for 24 hours	3ea	pass	
Box Drop Test	1 Corner 3 Edges 6 faces, 66㎝(MEDIUM BOX)	1box	pass	-

Note (1) ON Time over 10 seconds, OFF Time under 10 seconds

10. Cautions and Handling Precautions

10.1 Handling and Operating the Module

(1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
(2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
(3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
(4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
(5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
(6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
(7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
(8) Protect the module from static; it may cause damage to the CMOS ICs.
(9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
(10) Do not disassemble the module.
(11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
(12) Pins of I/F connector shall not be touched directly with bare hands.
(13) Do not connect, disconnect the module in the “Power ON” condition.
(14) Power supply should always be turned on/off by the item 6.1 Power On Sequence &6.2 Power Off Sequence

10.2 Storage and Transportation.

(1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 ℃ and relative humidity of less than 70%
(2) Do not store the TFT-LCD module in direct sunlight.
(3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
(4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.

(5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

11.Packing

----TBD----------

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MCT070LA12W1024600LML MCOT128064BY-WM MCOB21609AV-EWP MC42004A6W-SPTLY MC22008B6W-SPR MCT035G12W320240LML MC11605A6WR-SPTLY-V2 MC21605H6W-BNMLW-V2 MCOT048064A1V-YI MCT101E0CW1280800LMLIPS MCT104A0W1024768LML MCT070Z0W800480LML MCT0144C6W128128PML MCIB-16-LVDS-CABLE MC41605A6W-FPTLA-V2 MCOT128064UA1V-WM MCT101E0TW1280800LMLIPS MCT150B0W1024768LML MCT050HDMI-A-RTP MCT050HDMI-A-CTP MCT070Z0TW1W800480LML MCT050ACA0CW800480LML MC42008A6W-SPTLY MC42005A12W-VNMLY MC42005A12W-VNMLG MCT052A6W480128LML MC21605A6WK-BNMLW-V2 MCOT256064A1A-BM MCOT22005A1V-EYM MC20805A12W-VNMLG MC21605B6WD-BNMLW-V2 MC22405A6WK-BNMLW-V2 MC41605A6WK-FPTLW-V2 MCT101HDMI-A-RTP MCT024L6W240320PML MCCOG21605D6W-FPTLWI MC21605A6WD-SPTLY-V2 MC22005A6WK-BNMLW-V2 MC24005AA6W9-BNMLW-V2 MC42004A6WK-SPTLY-V2 MC11609A6W-SPTLY-V2 MCOT064048A1V-YM MCOT128064BY-BM MCCOG128064B12W-FPTLRGB MC11609A6W-SPR-V2 MC21605H6WK-BNMLW-V2 MCOT128064E1V-BM MCT070HDMI-B-RTP MDT5000C MCCOG42005A6W-BNMLWI